

Dear Esteemed Tender Participant,

In reference to the final technical proposal submitted for Miduk Phase II, we kindly request your compliance with the following instructions and the completion of the attached document by March 7, 2023:

1. Bid Bond Envelope containing either an Iranian Bank Guarantee in the amount of **IRR 2,500,000,000** or **Euro 50,000** in cash.

2. Technical Envelope containing:

2.1. Original signed and stamped technical proposal.

2.2. If applicable, the original copy of an authorization letter or agreement signed and stamped by partner companies. The scope of work of the partner companies should be clearly specified in the authorization letter or agreement. The authenticity of the signatories of this document should be confirmed by the Chamber of Commerce and legalized by the Iranian Embassy in your country.

2.3. Original signed and stamped Purchase Order (P.O) draft.

2.4. During the finalization of the commercial proposal and until the contract's Purchase Order is issued, technical clarifications regarding technical points and specifications can be addressed. (TCL)

3. Price Envelope including:

3.1. The CBS attached file should be completed by the vendor. All prices should be in Euro currency.

3.2. Commercial proposal.

3.3. We also emphasize that, like the technical envelope, it is necessary to provide technical clarification regarding the technical points and specifications when the commercial proposal is finalized and until the purchase order is issued.

LOCATION FOR RECEIVING THE ENVELOPE IN IRAN:

Address: 2nd. Floor, No. 13 (Canymes Building), Ave 2th Dead End, Ahmad Ghasir (Bokharest) Street, Tehran, Iran.

Postal Code: (---)

Telephone: (-----)

Fax: (----)

To: (-----)